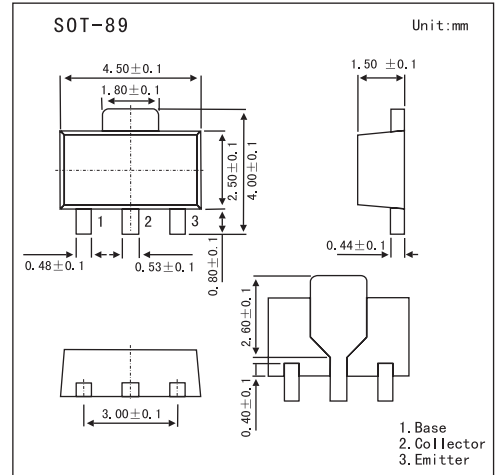


2SC4080

■ Features

- High Ft
- High breakdown voltage
- Small reverse transfer capacitance excellent high-frequency characteristic
- Adoption of FBET process



■ Absolute Maximum Ratings Ta = 25°C

Parameter	Symbol	Rating	Unit
collector-base voltage	V _{CB0}	200	V
collector-emitter voltage	V _{CE0}	200	V
emitter-base voltage	V _{EB0}	4	V
collector current	I _C	100	mA
Collector Current (pulse)	I _{CP}	200	mA
Collector Dissipation	P _C	500	mA
		1.3	W
Junction Temperature	T _J	150	°C
storage Temperature	T _{stg}	-55 to 150	°C

*Mounted on ceramic board (250mm²X0.8mm)

2SC4080

■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Testconditons	Min	Typ	Max	Unit
collector cutoff Current	ICBO	V _{CB} =150V, I _E =0			0.1	μA
Emitter cutoff current	IEBO	V _{EB} =2V, I _C =0			1.0	μA
DC Current Gain	hFE	V _{CE} =10V, I _C =10mA	40		320	
		V _{CE} =10V, I _C =100mA	20			
Gain-Bandwidth product	fr	V _{CE} =30V, I _C =30mA		400		MHz
Output Capacitance	cob	V _{CB} =30V, f=1MHz		1.8		pF
Reverse Transfer	cre	V _{CB} =30V, f=1MHz		1.4		
Collector to Emitter Saturation Voltage	V _{CE(sat)}	I _C =20mA, I _B =2mA			1	V
Base to Emitter Stauration Voltage	V _{BE(sat)}	I _C =20mA, I _B =2mA			1	V
Collector to Base Breakdown Voltage	V _{(BR)CBO}	I _C =10μA, I _E =0	200			V
Collector to Emitter Breakdown Voltage	V _{(BR)CEO}	I _C =1mA, I _B =0	200			V
Emitter to Base Breakdown Voltage	V _{(BR)EBO}	I _E =100μA, I _C =0	4			V

■ hFE Classification

Marking	CI			
	C	D	E	F
Type	40 to 80	60 to 120	100 to 200	160 to 320